NSN 5962-01-380-8109

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View Online at https://aerobasegroup.com/nsn/5962-01-380-8109 **Body Length:** 1.490 inches **Body Width:** Between 0.500 inches and 0.610 inches **Body Height:** 0.225 inches **Maximum Power Dissipation Rating:** 200.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **End Application:** Global positioning sys ue **Features Provided:** Burn in and electrostatic sensitive and radiation hardened and tested to mil-std-883 **Inclosure Material:** Ceramic **Inclosure Configuration:** Dual-in-line **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Criticality Code Justification:** Feat **Product Name:** Integrated circuit, ram **Voltage Rating And Type Per Characteristic:** -0.5 volts total supply and 7.0 volts total supply **Memory Device Type:** Ram **Special Features:** Electrostatic discharge sensitive/hardness critical item; static ram **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 28 printed circuit Shelf Life: N/a **Unit Of Measure:**

Demilitarization:

Yes - demil/mli

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